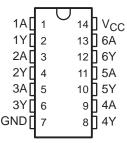
Dependable Texas Instruments Quality and Reliability

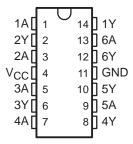
#### description/ordering information

These devices contain six independent inverters.

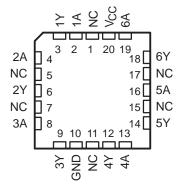
SN5404 ... J PACKAGE
SN54LS04, SN54S04 ... J OR W PACKAGE
SN7404, SN74S04 ... D, N, OR NS PACKAGE
SN74LS04 ... D, DB, N, OR NS PACKAGE
(TOP VIEW)



# SN5404 . . . W PACKAGE (TOP VIEW)



# SN54LS04, SN54S04 ... FK PACKAGE (TOP VIEW)



NC - No internal connection



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



#### **ORDERING INFORMATION**

TA	PAC	KAGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
		Tube	SN7404N	SN7404N
	PDIP – N	Tube	SN74LS04N	SN74LS04N
		Tube	SN74S04N	SN74S04N
		Tube	SN7404D	7404
		Tape and reel	SN7404DR	7404
	0010 5	Tube	SN74LS04D	1004
0°C to 70°C	SOIC - D	Tape and reel	SN74LS04DR	LS04
		Tube	SN74S04D	004
		Tape and reel	SN74S04DR	S04
		Tape and reel	SN7404NSR	SN7404
	SOP - NS	Tape and reel	SN74LS04NSR	74LS04
		Tape and reel	SN74S04NSR	74S04
	SSOP – DB	Tape and reel	SN74LS04DBR	LS04
		Tube	SN5404J	SN5404J
		Tube	SNJ5404J	SNJ5404J
	CDIP – J	Tube	SN54LS04J	SN54LS04J
	CDIP – J	Tube	SN54S04J	SN54S04J
		Tube	SNJ54LS04J	SNJ54LS04J
-55°C to 125°C		Tube	SNJ54S04J	SNJ54S04J
		Tube	SNJ5404W	SNJ5404W
	CFP – W	Tube	SNJ54LS04W	SNJ54LS04W
		Tube	SNJ54S04W	SNJ54S04W
	1.000 F1/	Tube	SNJ54LS04FK	SNJ54LS04FK
	LCCC – FK	Tube	SNJ54S04FK	SNJ54S04FK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

#### **FUNCTION TABLE** (each inverter)

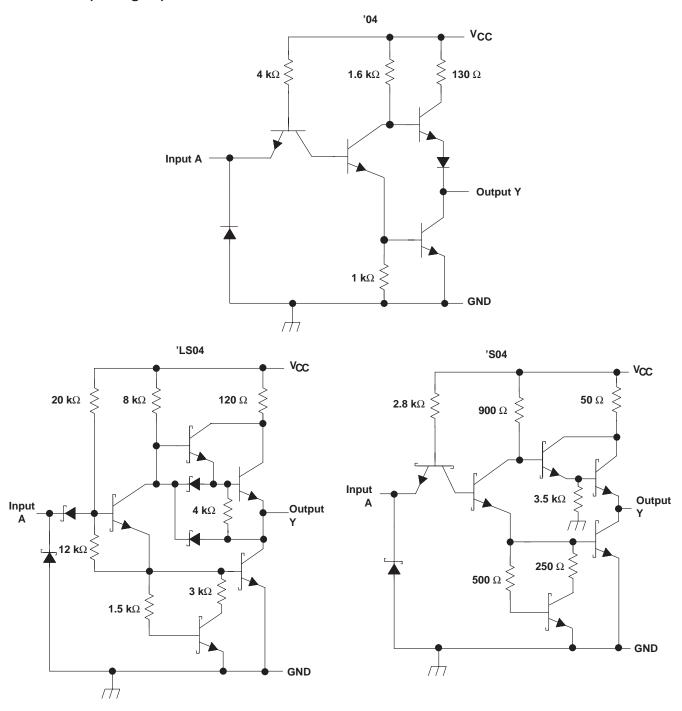
`	,
INPUT	OUTPUT
Α	Υ
Н	L
L	н



### logic diagram (positive logic)



#### schematics (each gate)



Resistor values shown are nominal.



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub> (see Note 1)		
Input voltage, V <sub>I</sub> : '04, 'S04		
'LS04		
Package thermal impedance, θ <sub>JA</sub> (see Note 2	2): D package	86°C/W
	DB package	96°C/W
	N package	80°C/W
	NS package	
Storage temperature range, T <sub>stg</sub>		

#### recommended operating conditions (see Note 3)

			SN5404		,	SN7404		UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
ІОН	High-level output current			-0.4			-0.4	mA
loL	Low-level output current			16			16	mA
TA	Operating free-air temperature	-55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER		TEGT CONDITIO			SN5404			SN7404		
PARAMETER		TEST CONDITIONS‡			TYP§	MAX	MIN	TYP§	MAX	UNIT
VIK	$V_{CC} = MIN,$	$I_{I} = -12 \text{ mA}$				-1.5			-1.5	V
Voн	$V_{CC} = MIN,$	$V_{IL} = 0.8 V$ ,	$I_{OH} = -0.4 \text{ mA}$	2.4	3.4		2.4	3.4		V
VOL	$V_{CC} = MIN,$	$V_{IH} = 2 V$ ,	$I_{OL} = 16 \text{ mA}$		0.2	0.4		0.2	0.4	V
lį	$V_{CC} = MAX$ ,	V <sub>I</sub> = 5.5 V				1			1	mA
lΗ	$V_{CC} = MAX$ ,	V <sub>I</sub> = 2.4 V				40			40	μΑ
I <sub>Ι</sub> Γ	$V_{CC} = MAX$ ,	V <sub>I</sub> = 0.4 V				-1.6			-1.6	mA
los¶	VCC = MAX			-20		-55	-18		-55	mA
Іссн	$V_{CC} = MAX$ ,	V <sub>I</sub> = 0 V			6	12		6	12	mA
ICCL	$V_{CC} = MAX$ ,	V <sub>I</sub> = 4.5 V			18	33		18	33	mA

<sup>‡</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. This are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to network ground terminal.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

<sup>§</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>¶</sup> Not more than one output should be shorted at a time.

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### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 1)

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST C	CONDITIONS		SN5404 SN7404		UNIT
		(INFOT)	(001701)				TYP	MAX	
I	<sup>t</sup> PLH	۸	V	P 400 O	C 15 pE		12	22	20
	<sup>t</sup> PHL	A	ſ	$R_L = 400 \Omega$ ,	C <sub>L</sub> = 15 pF		8	15	ns

#### recommended operating conditions (see Note 3)

		s	N54LS04	4	S	N74LS04	4	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
$V_{\text{IH}}$	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
ІОН	High-level output current			-0.4			-0.4	mA
lOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEGT CONDITIONS!		S	SN54LS04			SN74LS04			
PARAMETER	TEST CONDITIONS†			MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	UNIT	
VIK	V <sub>CC</sub> = MIN,	$I_{I} = -18 \text{ mA}$				-1.5			-1.5	V	
Voн	$V_{CC} = MIN,$	$V_{IL} = MAX$ ,	$I_{OH} = -0.4 \text{ mA}$	2.5	3.4		2.7	3.4		V	
	Vaa – MIN	V 2 V	$I_{OL} = 4 \text{ mA}$		0.25	0.4			0.4	V	
$V_{OL}$	$V_{CC} = MIN,$ $V_{IH} = 2 V$	I <sub>OL</sub> = 8 mA					0.25	0.5	V		
ΙĮ	$V_{CC} = MAX$ ,	V <sub>I</sub> = 7 V				0.1			0.1	mA	
lН	$V_{CC} = MAX$ ,	V <sub>I</sub> = 2.7 V				20			20	μΑ	
I <sub>IL</sub>	$V_{CC} = MAX$ ,	V <sub>I</sub> = 0.4 V				-0.4			-0.4	mA	
I <sub>OS</sub> §	VCC = MAX		_	-20		-100	-20		-100	mA	
ІССН	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0 V			1.2	2.4		1.2	2.4	mA	
ICCL	$V_{CC} = MAX$ ,	V <sub>I</sub> = 4.5 V	_		3.6	6.6		3.6	6.6	mA	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST C	CONDITIONS		N54LS04 N74LS04		UNIT
	(IIVI O1)	(0011 01)			MIN	TYP	MAX	
t <sub>PLH</sub>	^	V	D. 210	C: 45 pF		9	15	
<sup>t</sup> PHL	А	Ť	$R_L = 2 k\Omega$ ,	C <sub>L</sub> = 15 pF		10	15	ns



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

#### recommended operating conditions (see Note 3)

		8	N54S04		9	N74S04		LINUT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
V <sub>IL</sub>	Low-level input voltage			0.8			0.8	V
IOH	High-level output current			-1			-1	mA
lOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	-55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

24244555				(	SN54S04			N74S04		
PARAMETER		TEST CONDITION	ONSI	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	$V_{CC} = MIN,$	$I_{I} = -18 \text{ mA}$				-1.2			-1.2	V
Voн	$V_{CC} = MIN,$	$V_{IL} = 0.8 V$ ,	$I_{OH} = -1 \text{ mA}$	2.5	3.4		2.7	3.4		V
VOL	$V_{CC} = MIN,$	V <sub>IH</sub> = 2 V,	$I_{OL} = 20 \text{ mA}$			0.5			0.5	V
ΙĮ	$V_{CC} = MAX$ ,	V <sub>I</sub> = 5.5 V				1			1	mA
lН	$V_{CC} = MAX$ ,	V <sub>I</sub> = 2.7 V				50			50	μΑ
Ι <sub>Ι</sub> L	$V_{CC} = MAX$ ,	V <sub>I</sub> = 0.5 V				-2			-2	mA
los§	$V_{CC} = MAX$			-40		-100	-40		-100	mA
Іссн	$V_{CC} = MAX$ ,	V <sub>I</sub> = 0 V			15	24		15	24	mA
ICCL	$V_{CC} = MAX$ ,	V <sub>I</sub> = 4.5 V	-		30	54		30	54	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

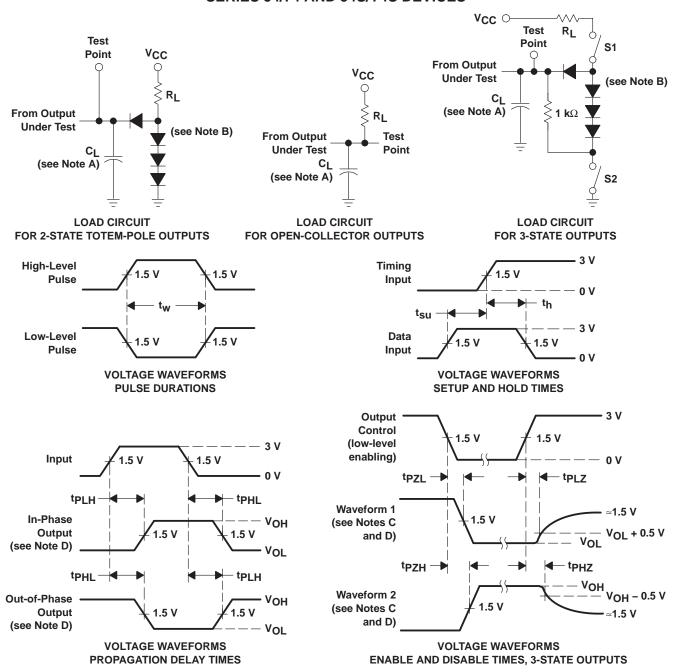
## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 1)

PARAMETER	PARAMETER FROM TO TEST CONDITIONS			N54S04 N74S04		UNIT		
	(INFOT)	(001-01)			MIN	TYP	MAX	
<sup>t</sup> PLH	۸	V	$R_1 = 280 \Omega$	C <sub>I</sub> = 15 pF		3	4.5	ns
tPHL	A	'	KL = 200 sz,	OL = 13 pr		3	5	115
tPLH .	۸	V	$R_1 = 280 \Omega$	C: - 50 pE		4.5		ns
<sup>t</sup> PHL	А	r	NL = 200 22,	C <sub>L</sub> = 50 pF		5		115

<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

#### PARAMETER MEASUREMENT INFORMATION SERIES 54/74 AND 54S/74S DEVICES

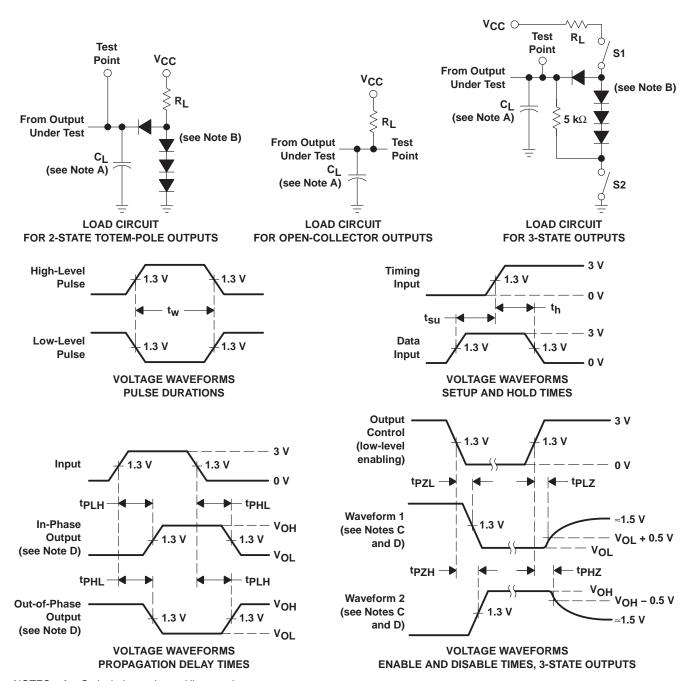


- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. All diodes are 1N3064 or equivalent.
  - C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
  - E. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_{\Omega} \approx 50 \Omega$ ;  $t_r$  and  $t_f \leq$  7 ns for Series 54/74 devices and  $t_r$  and  $t_f \le 2.5$  ns for Series 54S/74S devices.
  - F. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



#### PARAMETER MEASUREMENT INFORMATION **SERIES 54LS/74LS DEVICES**



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. All diodes are 1N3064 or equivalent.
  - C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - D. S1 and S2 are closed for tpLH, tpHL, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
  - E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
  - All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O \approx 50~\Omega$ ,  $t_f \leq$  1.5 ns,  $t_f \leq$  2.6 ns.
  - G. The outputs are measured one at a time, with one input transition per measurement.

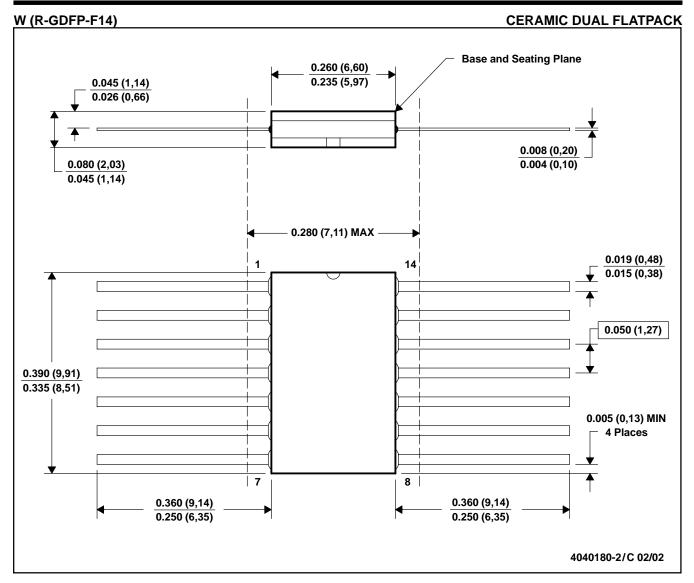
Figure 2. Load Circuits and Voltage Waveforms



#### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



## N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G14)

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



#### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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